

Typical Application Circuit

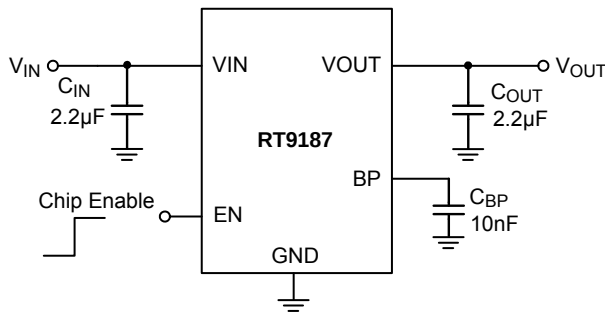


Figure 1. Fixed Operation

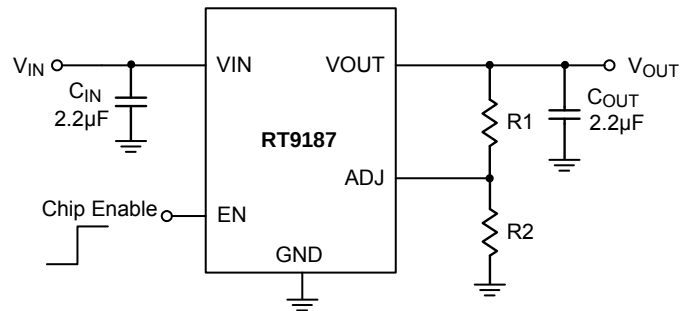


Figure 2. Adjustable Operation

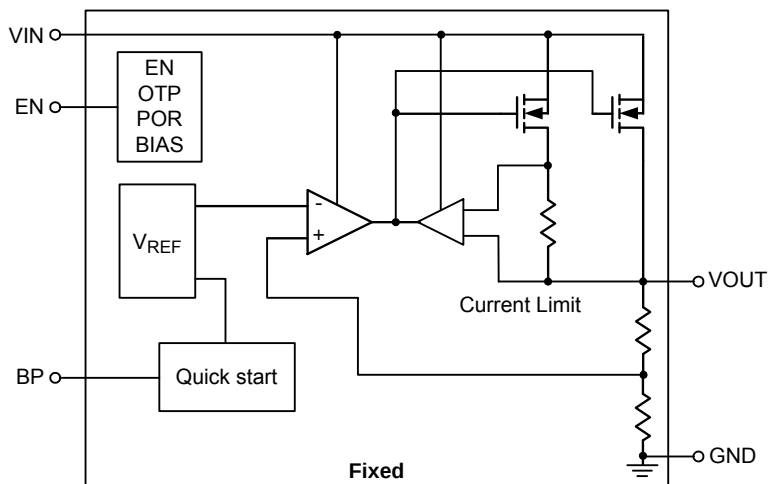
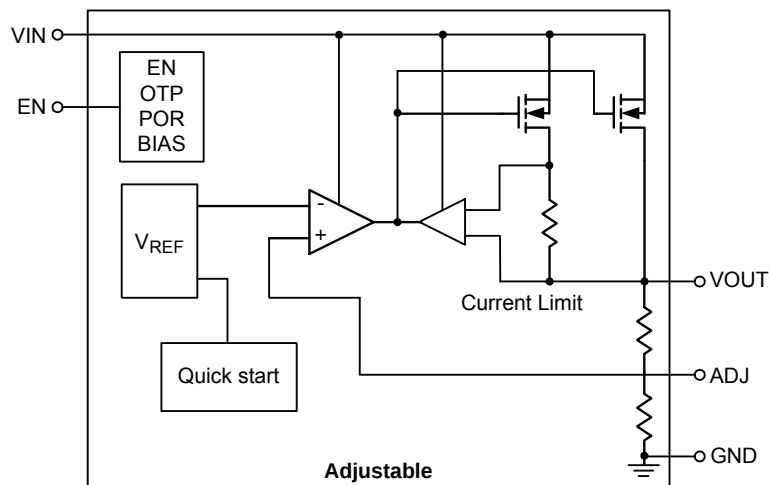
$$V_{OUT} = 0.8 \times \left(1 + \frac{R_1}{R_2}\right) \text{ Volts}$$

Note : The value of R2 should be less than 80k to maintain regulation.

Function Pin Description

Pin No.		Pin Name	Pin Function
Fixed Output Voltage	Adjustable Output Voltage		
1	1	VIN	Supply input.
2	2	VIN	Supply input.
3	3	VOUT	Regulator output.
4	4	VOUT	Regulator output.
5	--	BP	Noise reduction. Connecting a 10nF capacitor to GND to reduce output noise.
--	5	ADJ	If external feedback resistors are applied, the output voltage will be: $V_{OUT} = 0.8 \times \left(1 + \frac{R_1}{R_2}\right) V$
6, 9 (Exposed Pad)	6, 9 (Exposed Pad)	GND	Ground. The exposed pad must be soldered to a large PCB and connected to GND for maximum power dissipation.
7	7	NC	No internal connection.
8	8	EN	Enable input logic, active high. When the EN goes to a logic low, the device is in shutdown mode.

Functional Block Diagram



Absolute Maximum Ratings (Note 1)

• Supply Input Voltage	6V
• EN Input Voltage	6V
• Power Dissipation, P_D @ $T_A = 25^\circ\text{C}$	
VDFN-8L 3x3	1.429W
SOP-8 (Exposed Pad)	1.33W
• Package Thermal Resistance (Note 2)	
VDFN-8L 3x3, θ_{JC}	8.2°C/W
VDFN-8L 3x3, θ_{JA}	70°C/W
SOP-8 (Exposed Pad), θ_{JC}	15°C/W
SOP-8 (Exposed Pad), θ_{JA}	75°C/W
• Lead Temperature (Soldering, 10 sec.)	260°C
• Junction Temperature	150°C
• Storage Temperature Range	-65°C to 150°C
• ESD Susceptibility (Note 3)	
HBM	2kV
MM	200V

Recommended Operating Conditions (Note 4)

• Supply Input Voltage	2.5V to 5.5V
• EN Input Voltage	0V to 5.5V
• Junction Temperature Range	-40°C to 125°C
• Ambient Temperature Range	-40°C to 85°C

Electrical Characteristics

($V_{IN} = V_{OUT} + 1V$, $V_{EN} = V_{IN}$, $C_{IN} = C_{OUT} = 2.2\mu\text{F}$ (Ceramic) & $C_{BP} = 10\text{nF}$, $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Output Voltage Accuracy (Fixed Output Voltage)	ΔV_{OUT}	$I_{OUT} = 10\text{mA}$	-1.5	0	1.5	%
Output Voltage Range (Adjustable)	V_{OUT_Adj}		0.8	--	4.5	V
Quiescent Current (Note 5)	I_Q	$V_{EN} \geq V_{IH}$, $I_{OUT} = 0\text{mA}$	--	380	500	μA
Standby Current (Note 6)	I_{STBY}	$V_{EN} \leq V_{IL}$, $V_{IN} = 3.3V$	--	0.1	1	μA
Current Limit	I_{LIM}	$R_{LOAD} = 0.5\Omega$, $V_{IN} = 3.3V$	2	2.8	3	A
Dropout Voltage (Note 7)	V_{DROP}	$I_{OUT} = 0.25A$ (Note 9)	--	60	100	mV
		$I_{OUT} = 0.5A$	--	120	180	
		$I_{OUT} = 1.0A$	--	240	360	
Load Regulation (Note 8) (Fixed Output Voltage)	ΔV_{LOAD}	$V_{IN} = (V_{OUT} + 0.5V)$ $10\text{mA} < I_{OUT} < 1.0A$	--	0.4	--	%/A
EN Threshold Voltage	Logic-Low	V_{IL}	$V_{IN} = 3.3V$	--	--	V
	Logic-High	V_{IH}	$V_{IN} = 3.3V$	1.2	--	
Enable Pin Current	I_{EN}	$V_{IN} = 3.3V$, enable	--	0.1	1	μA

Parameter		Symbol	Test Conditions	Min	Typ	Max	Unit
Power Supply Rejection Rate	f = 100Hz	PSRR	I _{OUT} = 300mA	--	−60	--	dB
	f = 10kHz			--	−50	--	
Line Regulation		ΔV _{LINE}	V _{IN} = (V _{OUT} + 0.5) to 5.5V, I _{OUT} = 1mA	--	--	0.3	%
Start-Up Time		T _{Start_Up}	R _{LOAD} = 3Ω, 1nF ≤ C _{BP} ≤ 0.1μF	--	40	--	μs
Thermal Shutdown Temperature		T _{SD}		--	170	--	°C
Thermal Shutdown Hysteresis		ΔT _{SD}		--	30	--	
ADJ							
Reference Voltage Tolerance		V _{REF}		0.784	0.8	0.816	V
ADJ Pin Current		I _{ADJ}	V _{ADJ} = V _{REF}	--	10	100	nA

Note 1. Stresses listed as the above “Absolute Maximum Ratings” may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.

Note 2. θ_{JA} is measured in natural convection at T_A = 25°C on a high effective thermal conductivity four-layer test board of JEDEC 51-7 thermal measurement standard. The measurement case position of θ_{JC} is on the exposed pad of the package.

Note 3. Devices are ESD sensitive. Handling precaution is recommended.

Note 4. The device is not guaranteed to function outside its operating conditions.

Note 5. Quiescent, or ground current, is the difference between input and output currents. It is defined by I_Q = I_{IN} - I_{OUT} under no load condition (I_{OUT} = 0mA). The total current drawn from the supply is the sum of the load current plus the ground pin current.

Note 6. Standby current is the input current drawn by a regulator when the output voltage is disabled by a shutdown signal (V_{EN} > 1.8V).

Note 7. The dropout voltage is defined as V_{IN} - V_{OUT}, which is measured when V_{OUT} is V_{OUT(NORMAL)} - Σ 100mV.

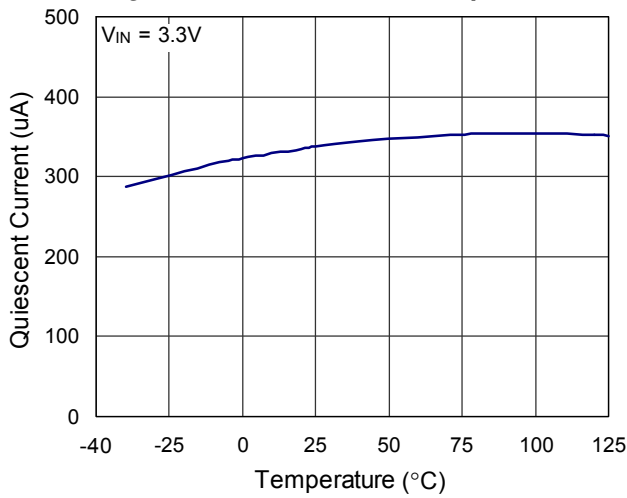
Note 8. Regulation is measured at constant junction temperature by using a 2ms current pulse. Devices are tested for load regulation in the load range from 10mA to 1.0A.

Note 9. Performance at -5°C ≤ T_A ≤ 85°C is assured by design.

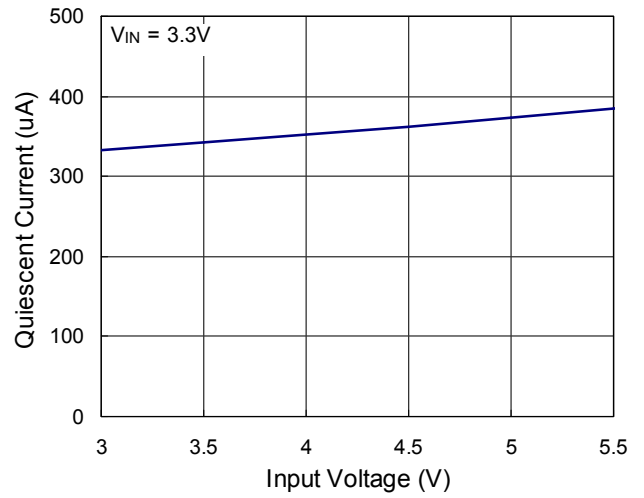
Typical Operating Characteristics

($C_{OUT} = 2.2\mu F/5R$, $C_{BP} = 10nF$, unless otherwise specified)

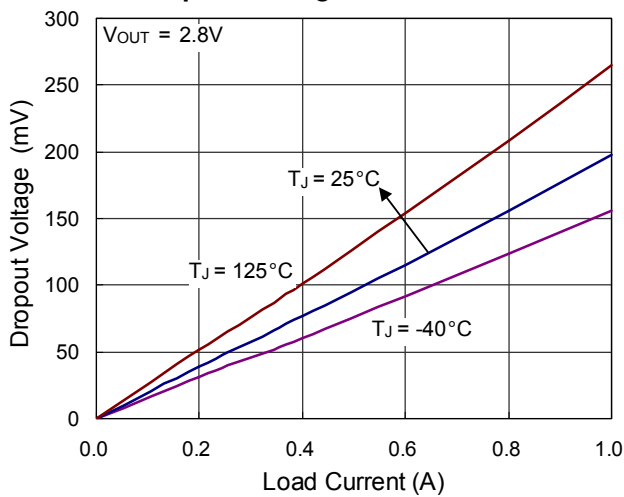
Quiescent Current vs. Temperature



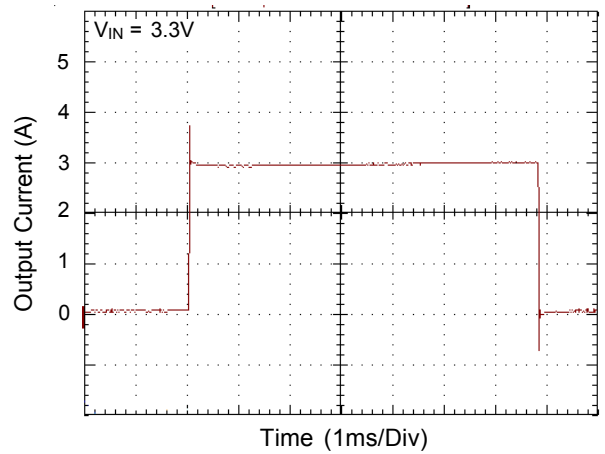
Quiescent Current vs. Input Voltage



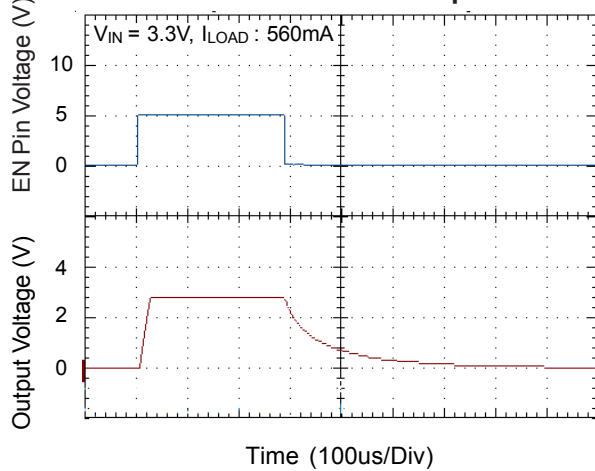
Dropout Voltage vs. Load Current



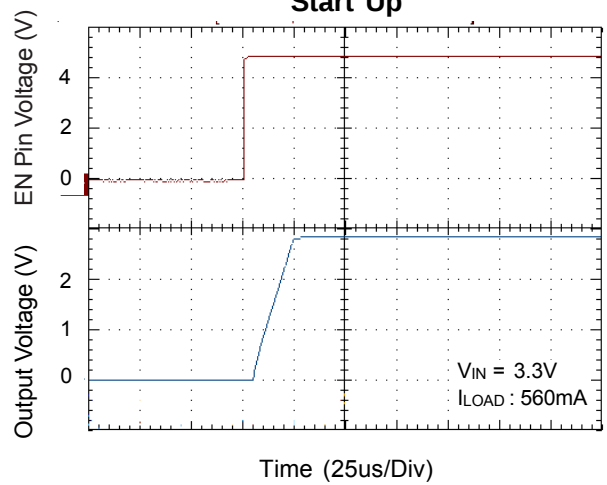
Current Limit



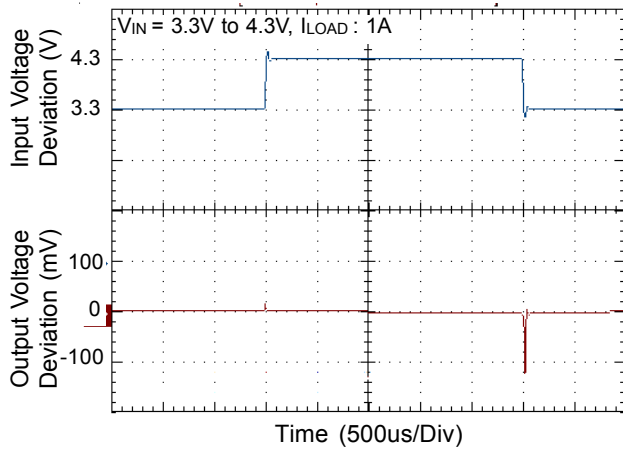
EN Pin Shutdown Response



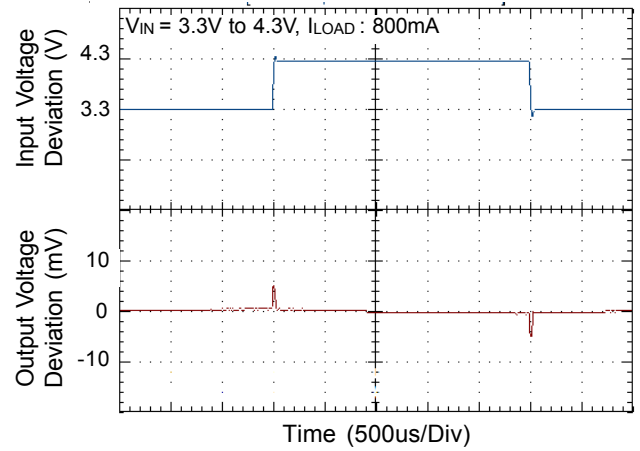
Start Up



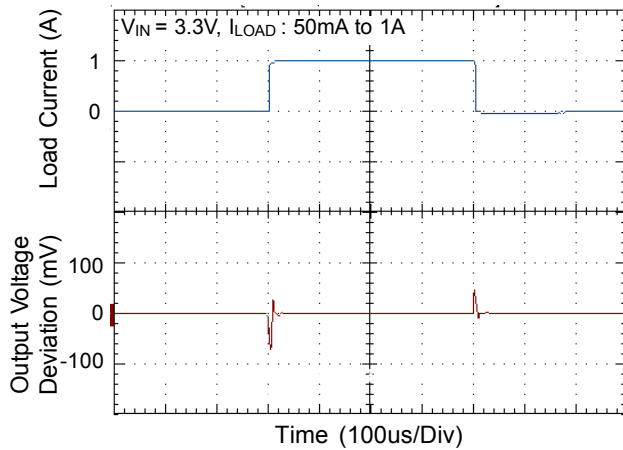
Line Transient Response



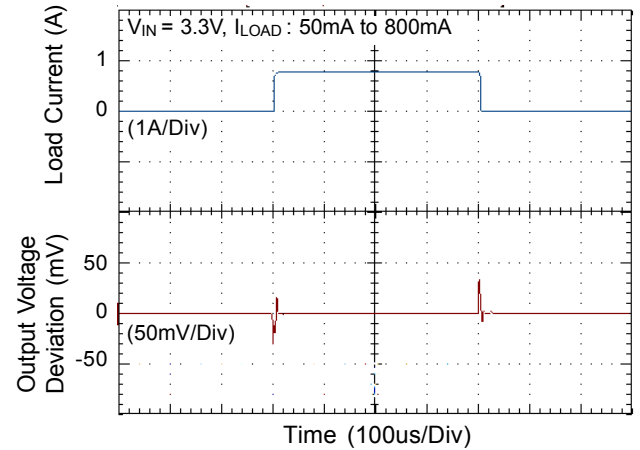
Line Transient Response



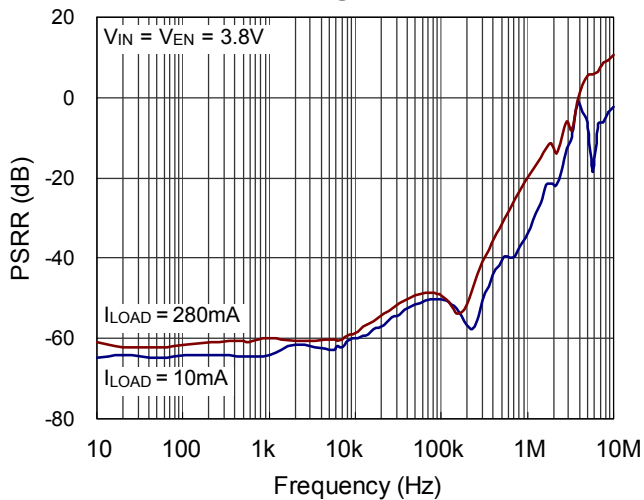
Load Transient Response



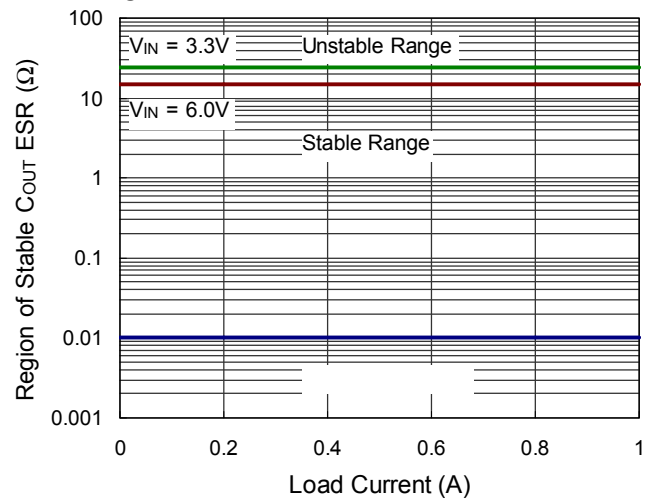
Load Transient Response



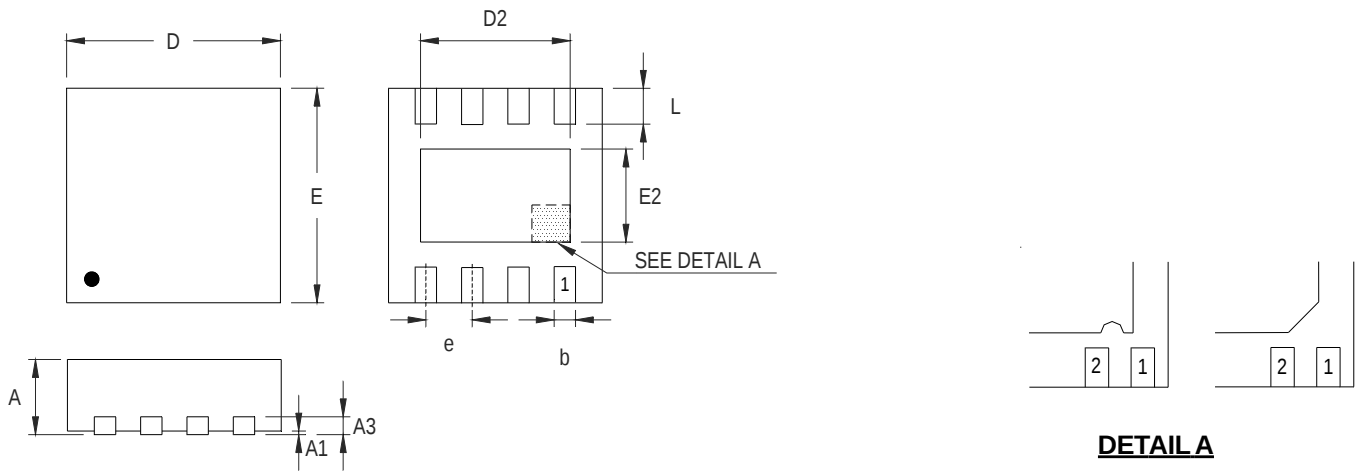
PSRR



Region of Stable C_{OUT} ESR vs. Load Current



Outline Dimension



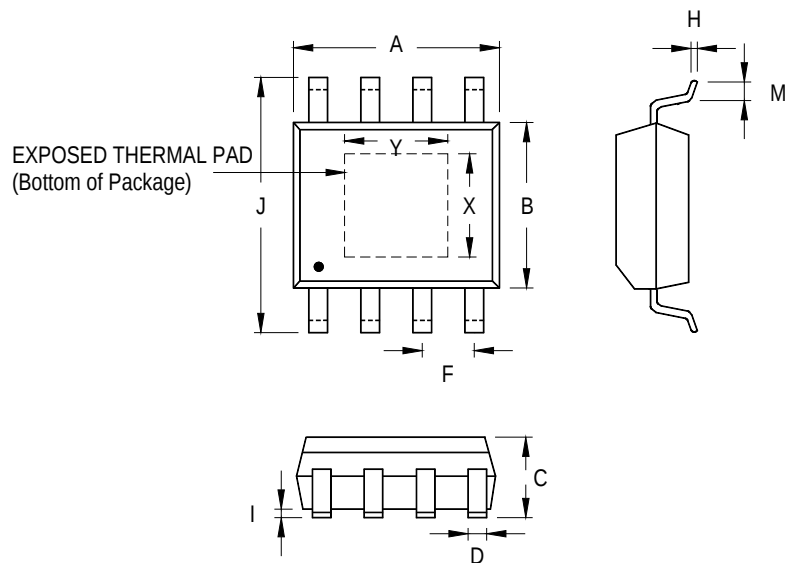
DETAIL A

Pin #1 ID and Tie Bar Mark Options

Note : The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.800	1.000	0.031	0.039
A1	0.000	0.050	0.000	0.002
A3	0.175	0.250	0.007	0.010
b	0.200	0.300	0.008	0.012
D	2.950	3.050	0.116	0.120
D2	2.100	2.350	0.083	0.093
E	2.950	3.050	0.116	0.120
E2	1.350	1.600	0.053	0.063
e	0.650		0.026	
L	0.425	0.525	0.017	0.021

V-Type 8L DFN 3x3 Package



Symbol		Dimensions In Millimeters		Dimensions In Inches	
		Min	Max	Min	Max
A		4.801	5.004	0.189	0.197
B		3.810	4.000	0.150	0.157
C		1.346	1.753	0.053	0.069
D		0.330	0.510	0.013	0.020
F		1.194	1.346	0.047	0.053
H		0.170	0.254	0.007	0.010
I		0.000	0.152	0.000	0.006
J		5.791	6.200	0.228	0.244
M		0.406	1.270	0.016	0.050
Option 1	X	2.000	2.300	0.079	0.091
	Y	2.000	2.300	0.079	0.091
Option 2	X	2.100	2.500	0.083	0.098
	Y	3.000	3.500	0.118	0.138

8-Lead SOP (Exposed Pad) Plastic Package

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